IRF644

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_a max. (nC)

Configuration

Power MOSFET

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

S

N-Channel MOSFET

0.28

250

68

11

35

Single

 $V_{GS} = 10 V$

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION		
Package	TO-220AB	
Lead (Pb)-free	IRF644PbF	
Lead (Pb)-free and halogen-free	IRF644PbF-BE3	

ABSOLUTE MAXIMUM RATINGS (T C	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	250	V	
Gate-source voltage			V _{GS}	± 20	- V	
Continuous drain current	V =======V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$		14		
	V _{GS} at 10 V	T _C = 100 °C	I _D	8.5	А	
Pulsed drain current ^a			I _{DM}	56		
Linear derating factor				1.0	W/°C	
Single pulse avalanche energy ^b			E _{AS}	550	mJ	
Repetitive avalanche current ^a			I _{AR}	14	A	
Repetitive avalanche energy ^a			E _{AR}	13	mJ	
Maximum power dissipation	T _C = 25 °C		PD	125	W	
Peak diode recovery dV/dt ^c			dV/dt	4.8	V/ns	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C		
Soldering recommendations (peak temperature) ^d	For	10 s		300	°C	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 4.5 mH, R_g = 25 Ω , I_{AS} = 14 A (see fig. 12)
- c. $I_{SD} \le 14$ A, dI/dt ≤ 150 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62		
Case-to-sink, flat, greased surface	R _{thCS}	0.50	-	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	1.0		

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		250	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, $I_D = 1 \text{ mA}$		0.34	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	4.0	V
Gate-source leakage	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
V _{DS} = 250 V	250 V, V _{GS} = 0 V	-	-	25			
Zero gate voltage drain current	IDSS	V _{DS} = 200 V	V _{DS} = 200 V, V _{GS} = 0 V, T _J = 125 °C		-	250	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 8.4 A ^b	-	-	0.28	Ω
Forward transconductance	9 _{fs}	V _{DS} = 50 V, I _D = 8.4 A ^b		6.7	-	-	S
Dynamic		•			•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	1300	-	pF
Output capacitance	C _{oss}			-	330	-	
Reverse transfer capacitance	C _{rss}			-	85	-	
Total gate charge	Qg		I _D = 7.9 A, V _{DS} = 200 V, see fig. 6 and 13 ^b	-	-	68	nC
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$		-	-	11	
Gate-drain charge	Q _{gd}			-	-	35	
Turn-on delay time	t _{d(on)}			-	11	-	ns
Rise time	t _r	V _{DD} =	V _{DD} = 125 V, I _D = 7.9 A,		24	-	
Turn-off delay time	t _{d(off)}	$R_g = 9.1 \Omega$, $R_D = 8.7 \Omega$, see fig. 10^{b}		-	53	-	
Fall time	t _f			-	49	-	
Gate input resistance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH
Internal drain inductance	L _S			-	7.5	-	
Internal source inductance	R _g	f = 1 MHz, open drain		0.3	-	1.2	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	IS	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14	A
Pulsed diode forward current ^a	I _{SM}			-	-	56	
Body diode voltage	V _{SD}	$T_{J} = 25 \ ^{\circ}C, \ I_{S} = 14 \ A, \ V_{GS} = 0 \ V^{b}$		-	-	1.8	V
Body diode reverse recovery time	t _{rr}	- T _J = 25 °C, I _F = 7.9 A, dl/dt = 100 A/μs ^b		-	250	500	ns
Body diode reverse recovery charge	Q _{rr}			-	2.3	4.6	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)					L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

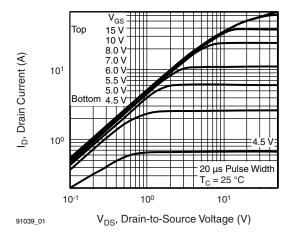


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

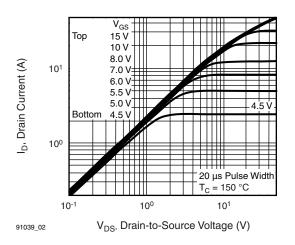


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

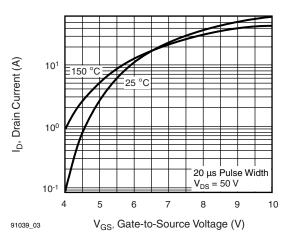


Fig. 3 - Typical Transfer Characteristics

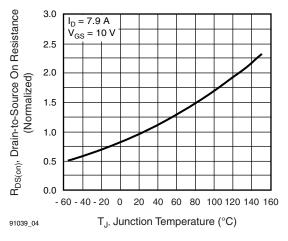


Fig. 4 - Normalized On-Resistance vs. Temperature

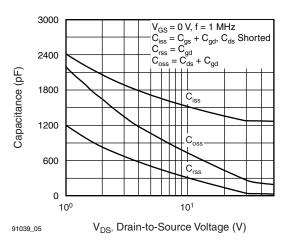


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

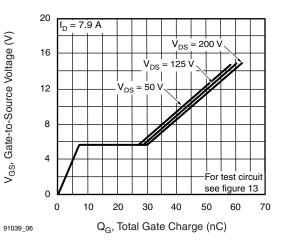


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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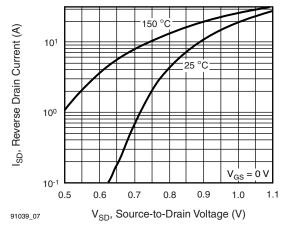


Fig. 7 - Typical Source-Drain Diode Forward Voltage

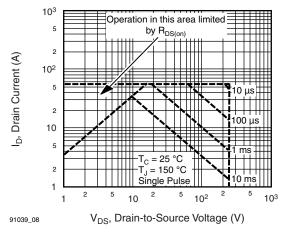


Fig. 8 - Maximum Safe Operating Area

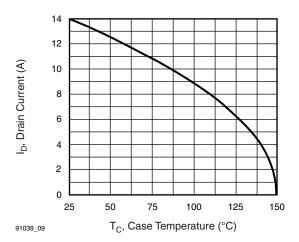


Fig. 9 - Maximum Drain Current vs. Case Temperature

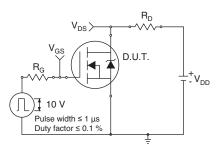


Fig. 10a - Switching Time Test Circuit

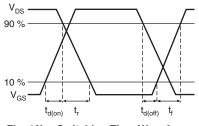


Fig. 10b - Switching Time Waveforms

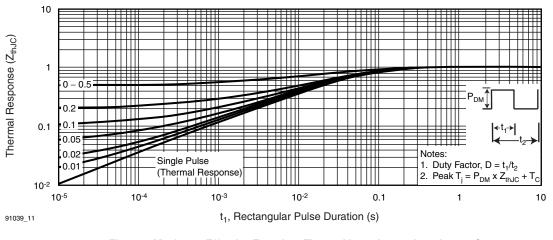


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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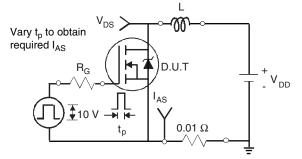
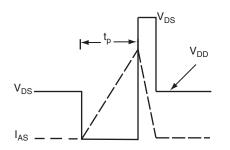


Fig. 12a - Unclamped Inductive Test Circuit





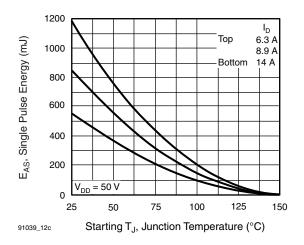
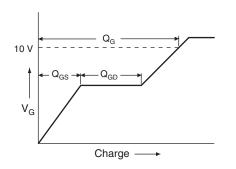
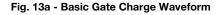


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





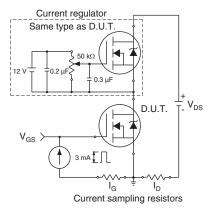
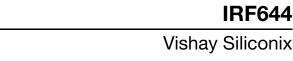


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

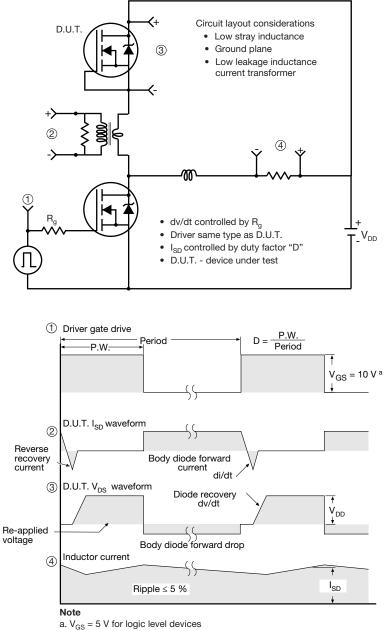


Fig. 14 - For N-Channel

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